

Document No.: FT001389

Clearance No.: FTDI#519

# Future Technology Devices International Ltd. FT602Q IC Datasheet (FIFO to USB 3.0 UVC Bridge)



The FT602 is a USB-to-FIFO interface to SuperSpeed USB (USB 3.1 Gen 1) USB Video Class (UVC) bridge chip with the following advanced features:

- Supports USB 3.1 GEN 1 Super Speed (5Gbps) / USB 2.0 High Speed (480Mbps)
- Supports USB Transfer Types: Control/Bulk/Interrupt
- Supports UVC version 1.1
- Supports up to 4 video input channels on the FIFO bus.
- Supports 2 parallel slave FIFO bus protocols, 245 FIFO and Multi-channel FIFO mode, with a data burst rate up to 400MB/s with 32 bit parallel interface

- Built-in 16kB FIFO data buffer RAM.
  - Built-in I<sup>2</sup>C master interface for video device configuration
- Supports multi voltage I/O: 1.8V, 2.5V and 3.3V.
- Internal LDO 1.0V regulator.
- Integrated power-on-reset circuit.
- User programmable USB and UVC descriptors.
- Industrial operating temperature range: -40 to 85°C.
- Available in compact Pb-free QFN-76 RoHS compliant package.

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# **1** Typical Applications

- USB 3.1 Digital Video Camera Interface
- USB 3.1 Digital Camera
- Medical/Industrial imaging devices
- USB 3.1 Instrumentation

### 1.1 Driver Support

### **USB Video Class Driver**

- Windows 10
- Windows 8.1
- Windows 7
- Mac OS-X
- Linux

### **1.2 Ordering Information**

| Part Number                   | Package  |  |  |
|-------------------------------|--|--|--|
| FT602Q-B-x                    | 76 Pin QFN 0.4mm Pitch, body 9mm x 9mm x 0.9mm |  |  |
| Table 1.1 Device Part Numbers |  |  |  |

#### Table 1.1 Device Part Numbers

**Note:** Packaging codes for x is:

-R: Taped and Reel, (VQFN in 3000 pieces per reel)

-T: Tray packing, (VQFN in 260 pieces per tray)

For example: FT602Q-B-R is 3000 QFN pieces in taped and reel packaging

### **1.3 USB Compliance**

The FT602Q is compliant with the USB 3.1 Gen 1 specification. Please contact us for further details on USB compliance.



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# 2 Block Diagram



Figure 2.1 Block Diagram

For a description of each function please refer to Section 4.



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# **3** Device Pin Out and Signal Description

### 3.1 Device Pin Out



Figure 3.1 FT602 Pin Out

### 3.2 Device Pin Out Signal Description

| Pin Name | Description  | Туре | Pin No. |
|----------|--|------|---------|
| CLK      | Parallel FIFO bus clock output pin to the FIFO bus master.<br>The Frequency can be configured as 66Mhz or 100Mhz for<br>both FIFO bus modes. | 0    | 58      |
| DATA_0   | Parallel FIFO bus data input bit 0.  | I    | 40      |
| DATA_1   | Parallel FIFO bus data input bit 1.  | I    | 41      |
| DATA_2   | Parallel FIFO bus data input bit 2.  | Ι    | 42      |

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| DATA_3Parallel FIFO bus data input bit 3.I43DATA_4Parallel FIFO bus data input bit 4.I44DATA_5Parallel FIFO bus data input bit 5.I45DATA_6Parallel FIFO bus data input bit 6.I46DATA_7Parallel FIFO bus data input bit 7.I47DATA_8Parallel FIFO bus data input bit 7.I47DATA_9Parallel FIFO bus data I/O bit 8.I/O50DATA_10Parallel FIFO bus data I/O bit 9.I/O51DATA_11Parallel FIFO bus data I/O bit 10.I/O52DATA_12Parallel FIFO bus data I/O bit 12.I/O54DATA_13Parallel FIFO bus data I/O bit 13.I/O55DATA_14Parallel FIFO bus data I/O bit 15.I/O57 |  |
|---|--|
| DATA_5Parallel FIFO bus data input bit 5.I45DATA_6Parallel FIFO bus data input bit 6.I46DATA_7Parallel FIFO bus data input bit 7.I47DATA_8Parallel FIFO bus data I/O bit 8.I/O50DATA_9Parallel FIFO bus data I/O bit 9.I/O51DATA_10Parallel FIFO bus data I/O bit 10.I/O52DATA_11Parallel FIFO bus data I/O bit 11.I/O53DATA_12Parallel FIFO bus data I/O bit 12.I/O54DATA_13Parallel FIFO bus data I/O bit 13.I/O55DATA_14Parallel FIFO bus data I/O bit 14.I/O56  |  |
| DATA_6Parallel FIFO bus data input bit 6.I46DATA_7Parallel FIFO bus data input bit 7.I47DATA_8Parallel FIFO bus data I/O bit 8.I/O50DATA_9Parallel FIFO bus data I/O bit 9.I/O51DATA_10Parallel FIFO bus data I/O bit 10.I/O52DATA_11Parallel FIFO bus data I/O bit 11.I/O53DATA_12Parallel FIFO bus data I/O bit 12.I/O54DATA_13Parallel FIFO bus data I/O bit 13.I/O55DATA_14Parallel FIFO bus data I/O bit 14.I/O56  |  |
| DATA_7Parallel FIFO bus data input bit 7.I47DATA_8Parallel FIFO bus data I/O bit 8.I/O50DATA_9Parallel FIFO bus data I/O bit 9.I/O51DATA_10Parallel FIFO bus data I/O bit 10.I/O52DATA_11Parallel FIFO bus data I/O bit 11.I/O53DATA_12Parallel FIFO bus data I/O bit 12.I/O54DATA_13Parallel FIFO bus data I/O bit 13.I/O55DATA_14Parallel FIFO bus data I/O bit 14.I/O56  |  |
| DATA_8Parallel FIFO bus data I/O bit 8.I/O50DATA_9Parallel FIFO bus data I/O bit 9.I/O51DATA_10Parallel FIFO bus data I/O bit 10.I/O52DATA_11Parallel FIFO bus data I/O bit 11.I/O53DATA_12Parallel FIFO bus data I/O bit 12.I/O54DATA_13Parallel FIFO bus data I/O bit 13.I/O55DATA_14Parallel FIFO bus data I/O bit 14.I/O56  |  |
| DATA_9Parallel FIFO bus data I/O bit 9.I/O51DATA_10Parallel FIFO bus data I/O bit 10.I/O52DATA_11Parallel FIFO bus data I/O bit 11.I/O53DATA_12Parallel FIFO bus data I/O bit 12.I/O54DATA_13Parallel FIFO bus data I/O bit 13.I/O55DATA_14Parallel FIFO bus data I/O bit 14.I/O56  |  |
| DATA_10Parallel FIFO bus data I/O bit 10.I/O52DATA_11Parallel FIFO bus data I/O bit 11.I/O53DATA_12Parallel FIFO bus data I/O bit 12.I/O54DATA_13Parallel FIFO bus data I/O bit 13.I/O55DATA_14Parallel FIFO bus data I/O bit 14.I/O56  |  |
| DATA_11Parallel FIFO bus data I/O bit 11.I/O53DATA_12Parallel FIFO bus data I/O bit 12.I/O54DATA_13Parallel FIFO bus data I/O bit 13.I/O55DATA_14Parallel FIFO bus data I/O bit 14.I/O56  |  |
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| DATA_13 Parallel FIFO bus data I/O bit 13. I/O 55   DATA_14 Parallel FIFO bus data I/O bit 14. I/O 56   |  |
| DATA_14 Parallel FIFO bus data I/O bit 14. I/O 56   |  |
|   |  |
| DATA_15 Parallel FIFO bus data I/O bit 15. I/O 57   |  |
|   |  |
| DATA_16 Parallel FIFO bus data input bit 16. I 60   |  |
| DATA_17 Parallel FIFO bus data input bit 17. I 61   |  |
| DATA_18Parallel FIFO bus data input bit 18.I62  |  |
| DATA_19 Parallel FIFO bus data input bit 19. I 63   |  |
| DATA_20 Parallel FIFO bus data input bit 20. I 64   |  |
| DATA_21 Parallel FIFO bus data input bit 21. I 65   |  |
| DATA_22 Parallel FIFO bus data input bit 22. I 66   |  |
| DATA_23 Parallel FIFO bus data input bit 23. I 67   |  |
| DATA_24 Parallel FIFO bus data input bit 24. I 69   |  |
| DATA_25 Parallel FIFO bus data input bit 25. I 70   |  |
| DATA_26 Parallel FIFO bus data input bit 26. I 71   |  |
| DATA_27 Parallel FIFO bus data input bit 27. I 72   |  |
| DATA_28 Parallel FIFO bus data input bit 28. I 73   |  |
| DATA_29 Parallel FIFO bus data input bit 29. I 74   |  |
| DATA_30 Parallel FIFO bus data input bit 30. I 75   |  |
| DATA_31Parallel FIFO bus data input bit 31.I76  |  |



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|           | -  |     |    |
|-----------|--|-----|----|
| BE_0      | Parallel FIFO bus byte enable I/O bit 0.   | I/O | 4  |
| BE_1      | Parallel FIFO bus byte enable I/O bit 1.   | I/O | 5  |
| BE_2      | Parallel FIFO bus byte enable I/O bit 2.   | I/O | 6  |
| BE_3      | Parallel FIFO bus byte enable I/O bit 3.   | I/O | 7  |
|           | 245 Synchronous FIFO mode: Transmit FIFO Empty output<br>signal. The signal indicates there is a minimum of 1 byte<br>of space available to write to. Only write to the FIFO when<br>this signal is logic 0. | 0   |    |
| TXE_N     | Multi-Channel FIFO mode: Status Valid output signal (optional).  |     | 8  |
| RXF_N     | 245 Synchronous FIFO mode: Add external pull up in<br>normal operation.<br>Multi-Channel FIFO mode: Data Receive Acknowledge<br>output signal.   | 0   | 9  |
| RESERVED1 | Reserved. Add external pull up in normal operation.  | Ι   | 10 |
|           | 245 Synchronous FIFO mode: Write Enable input signal.  |     |    |
|           | Multi-Channel FIFO mode: Data Transaction Request input signal.  | I   |    |
| WR_N      | The signal is active low.  |     | 11 |
| RESERVED2 | Add external pull up in normal operation.  | Ι   | 12 |
| RESERVED3 | Add external pull up in normal operation.  | Ι   | 13 |
| RESET_N   | Chip Reset input, Active low.  | Ι   | 15 |
| INT_N     | Interrupt input pin, active low.   | Ι   | 16 |
| RESERVED4 | Reserved. Do not connect.  | NC  | 19 |
| SCL       | I <sup>2</sup> C Serial Clock line   | OD  | 17 |
| SDA       | I <sup>2</sup> C Serial Data line  | OD  | 18 |
| VBUS      | USB BUS power detect pin. The input voltage should be greater than 2.7V.   | I   | 37 |
| XI        | Crystal input. This terminal is the crystal input for the internal oscillator.   | I   | 21 |
| хо        | Crystal Output. This terminal is the crystal output for the internal oscillator.   | 0   | 22 |
| DP        | Hi-speed USB differential transceiver (positive)   | I/O | 23 |
| DM        | Hi-speed USB differential transceiver (negative)   | I/O | 25 |



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| RREF  | PHY reference resistor input pin. Connect 1.6k $\Omega$ 1% resistor to ground, provides reference voltage to USB2 PHY. | I   | 27              |
|-------|--|-----|-----------------|
| TODN  | Super Speed USB transmitter differential pair (negative)   | 0   | 31              |
| TODP  | Super Speed USB transmitter differential pair (positive)   | 0   | 32              |
| RIDN  | Super Speed USB receiver differential pair (negative)  | Ι   | 34              |
| RIDP  | Super Speed USB receiver differential pair (positive)  | Ι   | 35              |
| VCC33 | +3.3V power input for chip and internal LDO.   | PWR | 20,24,3<br>8    |
| DV10  | +1.0V power output from internal LDO. Connecting to VD10 and AVDD, with a 4.7uF cap to ground is recommended.          | 0   | 39              |
| VD10  | +1.0V core voltage input.  | PWR | 3,30,33<br>,48  |
| VCCIO | Power input for I/O block, supports +2.5/+3.3V.  | PWR | 14,49,5<br>9,68 |
| VDDA  | +3.3V power input for USB2.0 and USB3.0 PHYs.  | PWR | 28              |
| AVDD  | +1.0V power input for PLL.   | PWR | 2               |
| GND   | Ground   | GND | 1,26,<br>29,36  |



### **4** Function Description

The FT602 is a high performance USB 3.1 UVC bridge with a FIFO interface. It is designed to transfer uncompressed YUV422 video data from the 32bit FIFO interface to the USB 3.1 bus. It supports resolutions and frame rates up to 1920x1080@60 frames per second. In FT600 multi-channel mode, up to 4 UVC channels of video may be transported. It can be used in those applications which require high resolution imaging devices.

The FIFO interface supports multi-voltage I/O of 1.8V, 2.5V or 3.3V and operating frequencies of 66MHz or 100MHz. At 100MHz operation only 2.5V or 3.3V I/O voltages are supported.

There are 2 different proprietary synchronous bus protocols supported; one FIFO bus protocol is called the "Multi-Channel FIFO" bus protocol, also known as the FT600 FIFO protocol and the other is the "245 Synchronous FIFO" bus protocol. The latter being an extension of the interface introduced in the FT232H/FT2232H devices.

\*FIFO bus data lines are driven by the FIFO master, the FT602 only reads data from the FIFO master.

### 4.1 Key Features and Function Description

#### **Functional Integration**

The following features are integral to the IC design: FIFO protocol management, USB 3.1 (Gen 1) controller, USB3.0 and USB2.0 PHYs, power management, clock generation, power-on-reset (POR) and LDO regulator.

#### **USB 3.1 Protocol Controller**

The USB 3.1 Protocol Controller manages the data stream from the device USB control endpoint. It handles the USB protocol requests generated by the USB host controller and the commands for controlling the functional parameters of the endpoint in accordance with the USB 3.1 specification. 32KB of burst buffers are available in the protocol controller. These buffers are allocated to the UVC channels according to the required video bandwidth. The factory programmed default is for a single UVC channel and all burst buffers are allocated to the single channel. The default configuration may be customised by using the FT602 Chip Configuration utility.

#### FIFO Management

This unit is used to manage all PIPE data or buffers in the FIFO memory; the data is sent or received through the FIFO protocol layer. Through this block the FIFO memory can be allocated to each PIPE with any size of memory as long as the total memory allocated to all PIPEs does not exceed the maximum FIFO memory size which is 16KB. Additionally, the FIFO signals have a configurable high drive strength capability and can be set to  $18\Omega$ ,  $25\Omega$ ,  $35\Omega$  and  $50\Omega$ .

#### Multi-Channel FIFO Bus protocol

The multi-Channel FIFO bus is a slave bus and is designed to handle Multi-Channel FIFO connectivity. The bus protocol supports a total of 4 IN channels. CLK is the clock output to the FIFO bus master.

#### 245 Synchronous FIFO Bus protocol

The 245 Synchronous FIFO bus is a slave bus with one IN FIFO channel supported by this bus protocol. CLK is the clock output to the FIFO bus master.

#### **FIFO Bus Clock Option**

The device provides the following FIFO bus clock frequency option: 66MHz, 100MHz.



### FIFO Buffer (16K bytes)

Data written into the FIFO is stored in the FIFO buffer and transferred to the USB endpoint buffers and prepared for transmission to the USB host. The data is transferred to the host whenever the IN endpoint is ready to receive data.

The FIFO and EPC burst buffers in the FT602 may be configured to correspond to the required throughput of the UVC channel. The factory programmed default configuration is for a single UVC channel with the entire 16KB FIFO buffer allocated to the single IN channel. The default configuration may be customised by using the FT602 Chip Configuration utility.

### Internal LDO Regulator

The LDO regulator generates the +1.0V power supply for driving the internal core of the device. This supply is not to be used for external devices and is meant for decoupling.

#### **Reset Generator**

The integrated Reset Generator module provides a reliable power-on reset to the device internal circuitry at power up. The RESET\_N input pin allows an external device to reset the FT602. This pin is an active low input.

#### Interrupt

One interrupt pin is provided; this pin can be used for  $I^2C$  interrupt request or to wake up the FT602 device from sleep mode.

### I<sup>2</sup>C bus

The FT602 provides an I<sup>2</sup>C bus which operates as master, the transmission speed defaults to 800 Kb/s.

#### **USB Video Class Device**

The UVC device has configurations for SuperSpeed, Hi-speed, and full speed devices. The device is compliant to UVC Version 1.1 and supports the following features.

- Up to 14 customisable resolutions each in FS, HS, SS modes, up to UHD.
- Up to 4 UVC sources simultaneously.
- Up to 60fps of F-HD input.

### 4.2 Multi-Channel FIFO mode Protocols

The FIFO interface is a slave bus and is designed to handle multi-channel connectivity. The bus protocol supports a total of 4 IN channels; each has a corresponding USB IN endpoint. CLK is the clock output from the bus slave to the bus master.

The channel numbers denoted in this document as channels 1 to 4 are mapped to USB endpoint numbers 1 to 4. The USB IN endpoint in Channel 1 is denoted as USB IN channel 1.

Correspondingly, the FIFO IN is for data transmitted from the USB device to the host.

WR\_N is the bus master to bus slave data transaction request signal, and it is active low.

RXF\_N is the bus slave to bus master data receive acknowledge signal, and it is active low.

TXE\_N (optional signal, the master can ignore this signal) is the bus slave to bus master FIFO idle status valid signal, and it is active low.

DATA[31:0] is used as the 32-bit data bus during the data transfer phase. When the bus is in the idle state DATA[31:16], DATA[7:0] and BE[3:0] are driven to logic"1" by the bus master, and DATA[15:8] is driven by the bus slave to provide the FIFO status to the bus master. The lower nibble (DATA[11:8]) provides the 4 IN channels FIFO status. They are all active low.



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For example, at idle, DATA[8] is logic"0", which indicates USB IN channel 1 FIFO space is empty and able to receive data . The external bus master will start a transfer cycle by asserting WR\_N based on the channel FIFO status. The first cycle after WR\_N is asserted is the command phase, followed by the data phase when RXF\_N is asserted. At the command phase, the bus master will send the channel number which it intends to transfer data with on DATA[7:0] and the Write command on BE[3:0]. BE[3:0] = 'h1 indicates a master write. There may also be a required turn-a-round for DATA[31:0] and BE[3:0] after the command phase and at the end of data transaction.

Table 4.1 shows Multi-Channel FIFO mode command phase master write and channel address setting.

| Command Phase | FT602 Command<br>BE[3:0] | Channel Address DATA[7:0]                          |  |
|---------------|--------------------------|--|--|
| Master Write  | 0001                     | 8'h1=Channel 1                                     |  |
|               |                          | 8'h2=Channel 2                                     |  |
|               |                          | 8'h3=Channel 3                                     |  |
|               |                          | 8'h4=Channel 4                                     |  |
|               |                          | All other values are reserved and shall be ignored |  |

Table 4.1 Multi-Channel FIFO mode Command phase

**Note:** The channels can be configured by using the FT602 Chip Configuration utility.

The waveform below shows a FT602 master write transaction for 14 bytes at channel 1 with the bus master terminating the transaction. There are turn-a-round cycles for DATA[15:8] after the command phase and at the end of the data transaction. The BE[3:0] shows that the lower 2 bytes in D3 are valid at the last word strobe in this transaction.



#### Figure 4.1 Multi-Channel FIFO mode master write transaction 1

**NOTE:** There is no turnaround phase for BE pins as these remain inputs when the FIFO is being written to by the master.

The waveform below shows a FT602 master write transaction where the FIFO at channel 1 uses all data space first, the RXF\_N reasserts when the FIFO data space is not available after D3. There are turn-a-round cycles for DATA[15:8] after the command phase and at the end of the data transaction. The BE[3:0] shows that the transaction is all word aligned, all 4 bytes in D3 are valid at the last word strobe in this transaction.







### 4.3 245 Synchronous FIFO mode Protocols

This FT602 slave FIFO bus uses one IN FIFO channel while in this mode.

CLK is the clock output to the bus master; it can be configured as 66 MHz or 100 MHz

TXE\_N is an output signal, Transmit FIFO Empty. It is active low and when active it indicates the Transmit FIFO has space and it is ready to receive data from the FIFO master.

WR\_N is an input signal, Write Enable. It is active low and when it is driven low by the bus master, the master has write cycle access.

BE[3:0] is the byte enable signal. In bus master write operation, the bus master asserts the signal for the valid bytes in a word strobe. Normally, all 4 bytes should be valid in a bus transaction except in the last word strobe when the data transaction length is not aligned at a word boundary. The waveform below shows 245 synchronous FIFO bus master write cycles.



#### Figure 4.3 245 Synchronous FIFO mode bus master write cycle

\*In 245 Synchronous FIFO mode master write operation, if the bus master expects the data to be transferred on the USB bus in a maximum possible packet length, it should write the data to the FIFO in a single bus transaction.

### 4.4 FIFO Bus AC Timing

# The FT602 device FIFO bus is a synchronous parallel bus. The CLK signal is generated by the device, with the typical FIFO clock duty cycle of 50%. Both Multi-Channel and 245 synchronous FIFO modes' worst case AC timing are shown in

Figure 4.4 and Table 4.2.

In this figure, 'Input Data' includes all control signals and data lines driven by the FIFO master. 'Output Data' includes all control signals driven by the FIFO slave - FT602.

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Figure 4.4 FIFO Bus AC timing diagram

| Time | Description                   | Minimum | Maximum | Unit |
|------|-------------------------------|---------|---------|------|
| T1   | Slave Drive Data Set Up Time  | 3.0     | -       | ns   |
| Т2   | Slave Drive Data Hold Time    | 3.5     | -       | ns   |
| Т3   | Master Drive Data Set Up Time | 1       | -       | ns   |
| T4   | Master Drive Date Hold Time   | 4.8     | -       | ns   |

Table 4.2 FIFO Bus AC timing

### 4.5 Crystal Requirements

The FT602 device requires an external clock source to control the internal circuitry.

The recommended parameters for the crystal are: 30MHz  $\pm$ 20ppm Crystal 18pF 50 Ohm -40°C ~ 85°C. The crystal should be connected across the XI and XO pins.

Note: Replacing the crystal with an oscillator or other clock source by tying XO to GND is not supported

### 4.6 I<sup>2</sup>C Interface

The I<sup>2</sup>C master supports 3 operating frequencies, 800 kHz, 400 kHz and 100 kHz. The frequency may be set through the FT602 configuration utility. The I<sup>2</sup>C master issues repeated start for read operations and it does not support arbitration and clock stretching.

I<sup>2</sup>C commands are issued by FT602 under the following conditions:

- 1. FT602 defined commands to convey video resolution selection and start of streaming
- 2. UVC command (camera and processing unit) pass through to I<sup>2</sup>C slave device
- 3. Side-band pass through (opaque data) by user supplied host application via configuration interface. Slave device initiated communication can be retrieved

<u>AN 434 FT602 UVC Bus Master Sample</u> describes the I<sup>2</sup>C slave register map.



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# **5** Devices Characteristics and Ratings

### **5.1 Absolute Maximum Ratings**

The absolute maximum ratings for the FT602 devices are as follows. These are in accordance with the Absolute Maximum Rating System (IEC 60134). Exceeding these may cause permanent damage to the device.

| Parameter                                     | Value              | Unit      |
|---|--------------------|-----------|
| Storage Temperature                           | -65°C to 150°C     | Degrees C |
| Ambient Operating Temperature (Power Applied) | -40°C to 85°C      | Degrees C |
| VCC33/VDDA Supply Voltage                     | -0.3 to +4.6       | V         |
| VCCIO Supply Voltage                          | -0.3 to +4.0       | V         |
| VD10 Core Supply Voltage                      | -0.5 to +1.4       | V         |
| AVDD PLL Supply Voltage                       | -0.5 to +1.4       | V         |
| IOs DC Input Voltage                          | -0.5 to +VCCIO+0.5 | V         |

Table 5.1 Absolute Maximum Ratings

### 5.2 ESD and Latch-up Specifications

| Description                  | Reference                               | Min | Typical | Max | Units |
|------------------------------|---|-----|---------|-----|-------|
| Human Body Mode<br>(HBM)     | JEDEC EIA/JESD22- A114-<br>B, Class 2   | -   | ±2kV    | -   | kV    |
| Machine mode<br>(MM)         | JEDEC EIA/JESD22- A115-<br>A, Class B   | -   | ±200V   | -   | V     |
| Charged Device<br>Mode (CDM) | JEDEC EIA/ JESD22-C101-<br>D, Class-III | -   | ±500V   | -   | V     |
| Latch-up                     | JESD78, Trigger Class-II                | -   | ±200mA  | -   | mA    |

Table 5.2 ESD and Latch-Up Specifications



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# 5.3 DC Characteristics

### 5.3.1 DC Characteristics (Ambient Temperature = -40°C to +85°C)

| Parameter  | Description                          | Min  | Typical | Max  | Units | Conditions                |
|------------|--------------------------------------|------|---------|------|-------|---------------------------|
| VCC33/VDDA | VCC Operating Supply<br>Voltage      | 3.0  | 3.3     | 3.6  | V     |                           |
| VCCIO_1    | VCCIO Operating<br>Supply Voltage    | 3.0  | 3.3     | 3.6  | V     | VCCIO=3.3V                |
| VCCIO_2    | VCCIO Operating<br>Supply Voltage    | 2.3  | 2.5     | 2.7  | V     | VCCIO=2.5V                |
| VCCIO_3    | VCCIO Operating<br>Supply Voltage    | 1.65 | 1.8     | 1.95 | V     | VCCIO=1.8V                |
| VD10/AVDD  | Core/PLL Operating<br>Supply Voltage | 0.9  | 1.0     | 1.1  | V     |                           |
| Icc_1      | VCC Operating Supply<br>Current      | -    | 85      | -    | mA    | Idle, SuperSpeed          |
| Icc_2      | VCC Operating Supply<br>Current      | -    | 69      | -    | mA    | Idle, High Speed          |
| Icc_3      | VCC Operating Supply<br>Current      | -    | 185     | -    | mA    | FHD 1080P@60fps<br>Output |
| Icc_3      | VCC Operating Supply<br>Current      | -    | 4       | -    | mA    | USB Suspend               |
| Iccio_1    | VCCIO Operating<br>Supply Current    | -    | 4.5     | -    | mA    | No data transfer          |
| Iccio_2    | VCCIO Operating<br>Supply Current    |      | 9.5     |      | mA    | Data transfer             |
| Iccio_3    | VCCIO Operating<br>Supply Current    |      | 70      |      | μA    | USB Suspend               |

**Table 5.3 DC Characteristics** 



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### 5.3.2 DC Characteristics for I/O Interface

| Parameter        | Description                        | Min           | Typical | Max               | Units | Conditions               |
|------------------|------------------------------------|---------------|---------|-------------------|-------|--------------------------|
| VCCIO_3.3V       |                                    | 3.0           | 3.3     | 3.6               | V     | Normal<br>Operation      |
| VCCIO_2.5V       | VCCIO Operating<br>Supply Voltage  | 2.3           | 2.5     | 2.7               | V     | Normal<br>Operation      |
| VCCIO_1.8V       |                                    | 1.65          | 1.8     | 1.95              | V     | Normal<br>Operation      |
| VIH              |                                    | VCCIO*0<br>.7 | -       | -                 | V     | Normal<br>Operation      |
| VIL              |                                    | -             | -       | VCCI<br>O*0.<br>3 | V     | Normal<br>Operation      |
| Iin/Iout(3.3V)   | Input/output Leakage               | -10           | -       | 10                | uA    | Without pull-<br>up/down |
| Rpu/Rpd          | Input pull-up/pull down resistance | 30            | 50      | 75                | KΩ    | Vout=0~<br>VCCIO         |
| Iout(VCCIO=3.3V) | Output drive strength              | 10            | -       | -                 | mA    | Total current            |
| Iout(VCCIO=2.5V) | Output drive strength              | 9.4           | -       | -                 | mA    | Total current            |
| Ср               | Pin Capacitance                    | -             | -       | 2.0               | pF    |                          |

Table 5.4 DC Characteristics for I/O Interface (Except USB PHY pins)



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### **6 USB Power Configurations**

The following sections illustrate possible USB power configurations for the FT602. The illustrations have omitted pin numbers for ease of understanding.

### 6.1 USB Bus-Powered Configuration

**Note:** The reference designs here are for USB 3.1 Standard B or Micro-B connectors.



Figure 6.1 Bus-Powered Configuration-1.8V/2.5V I/O

Figure 6.1 illustrate the FT602 in a typical USB bus powered design configuration. The FT602 device gets its power(VCC33) from the USB bus via an external LDO(LDO\_3V3) stepping the voltage down to +3.3V. Another external LDO stepping the voltage down to +2.5V for supplying the VCCIO power, connect VCCIO pins to same LDO(LDO\_3V3) if VCCIO is configured to 3.3V.

A ferrite bead is connected in series with the USB power supply to reduce EMI noise from the FT602 and associated circuitry being radiated down the USB cable to the USB host. The value of the Ferrite Bead depends on the total current drawn by the application.



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### 6.2 Self-Powered Configuration



Figure 6.2 Self-Powered Configuration

Figure 6.2 illustrates the FT602 in a typical USB self-powered configuration. The FT602 device gets its power from its own power supply, VCC33 and VCCIO, and does not draw current from the USB bus.

The basic rules for USB self-powered devices are as follows -

- i) A self-powered device should not force current down the USB bus when the USB host or hub controller is powered down.
- ii) A self-powered device can use as much current as it needs during normal operation and USB suspend as it has its own power supply.
- iii) A self-powered device can be used with any USB host, a bus powered USB hub or a self-powered USB hub.



## 7 Application Example

The following sections illustrate the typical application of the FT602 UVC bridge device. The illustrations have omitted pin numbers for ease of understanding.

A typical example of the FT602 UVC Bridge to FIFO Master Interface is illustrated in Figure 7.1 and Figure 7.2.

### 7.1 FT602 Connect to FIFO Master Interface



Figure 7.1 FT602 Connect to FIFO Master Interface (Multi-Channel FIFO Mode)



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Figure 7.2 FT602 Connect to FIFO Master Interface (245 Synchronous FIFO Mode)

**Note:** I<sup>2</sup>C bus can connect to others I<sup>2</sup>C slave device, e.g. I<sup>2</sup>C interface EEPROM.



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# 8 Package Parameters

The FT602 is available in a QFN-76 package.

### 8.1 QFN-76 Package Mechanical Dimensions



#### Figure 8.1 QFN-76 Package Dimensions

The FT602Q is supplied in a RoHS compliant leadless QFN-76 package. The package is lead ( Pb ) free, and uses a 'green' compound. The package is fully compliant with European Union directive 2002/95/EC.

This package is nominally 9.0mm x 9.0mm body. The solder pads are on a 0.40mm pitch. The above mechanical drawing shows the QFN-76 package.

The centre pad on the base of the FT602Q is internally connected to GND, the PCB should connect to ground and not have signal tracking on the same layer as chip in this area.



# 8.2 QFN-76 Package Markings



#### Figure 8.2 QFN-76 Package Markings

#### Notes:

- 1. YYWW = Date Code, where YY is year and WW is week number
- 2. Marking alignment should be centre justified
- 3. Laser Marking should be used
- 4. All marking dimensions should be marked proportionally. Marking font should be using Greatek standard font (Roman Simplex)



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## 8.3 Solder Reflow Profile



Figure 8.3 Solder Reflow Profile



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# **Appendix A – References**

### **Document References**

Useful Application Notes <u>AN 434 FT602 UVC Bus Master Sample</u> Modules Datasheet <u>DS UMFT602EVM module datasheet</u> Utility <u>FT602ChipConfigurationProg</u>

### **Acronyms and Abbreviations**

| Terms            | Description                                   |
|------------------|---|
| ESD              | Electro Static Discharge                      |
| FIFO             | First In First Out                            |
| FPGA             | Field Programmable Gate Array                 |
| I <sup>2</sup> C | Inter-Integrated Circuit                      |
| LDO              | Low Drop Out regulator                        |
| QFN              | Quad Flat Non-leaded package                  |
| RoHS             | Restriction of Hazardous Substances Directive |
| USB              | Universal Serial Bus                          |
| VQFN             | Very Thin Quad Flat Non-Leaded Package        |



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# Appendix C – Revision History

| Document Title:         | FT602Q IC Datasheet                    |
|-------------------------|--|
| Document Reference No.: | FT001389                               |
| Clearance No.:          | FTDI#519                               |
| Product Page:           | http://www.ftdichip.com/FTProducts.htm |
| Document Feedback:      | Send Feedback                          |

| Revision    | Revision Changes   |            |
|-------------|--|------------|
| Version 1.0 | Initial Release  | 2017-02-21 |
| Version 1.1 | Updated Release (Data_8 to<br>Data_15 change to I/O from<br>input in section 3.2<br>Corrected section 4.2 Multi-<br>channel mode descriptions) | 2017-05-05 |
| Version 1.2 | Table 4.2 has been updated with<br>new timing values   | 2017-11-03 |
| Version 1.3 | Updated the Part Number in<br>section 1.2; Updated section1.3<br>and Figure 2.1; Updated package<br>marking in section 8.2                     | 2017-12-11 |
| Version 1.4 | Updated Figure 4.4 and figure references throughout the document.  | 2019-11-29 |